

# TSD-9A30-703

## Implant VCSEL Emitter(940nm)

### ELECTRO-OPTICAL CHARACTERISTICS :

PARAMETERS	SYMBOL	MIN	TYP	MAX	UNIT	CONDITIONS
Threshold Current	$I_{th}$		6		mA	
Output Power	$P_o$	8	11	14	mW	$I_F=24mA$
Slope Efficiency	$\eta$		0.60		mW/mA	
Forward Voltage	$V_F$		2.1	2.25	V	$I_F=24 mA$
Series Resistance	$R_s$		20		$\Omega$	
Wavelength	$\lambda_P$	930	940	955	nm	$I_F=24mA$
Beam Divergence	$\theta$		15		degree	$I_F=24 mA (1/e^2)$

Notes:

All parameters except mentioned are measured at 25°C, CW operation.

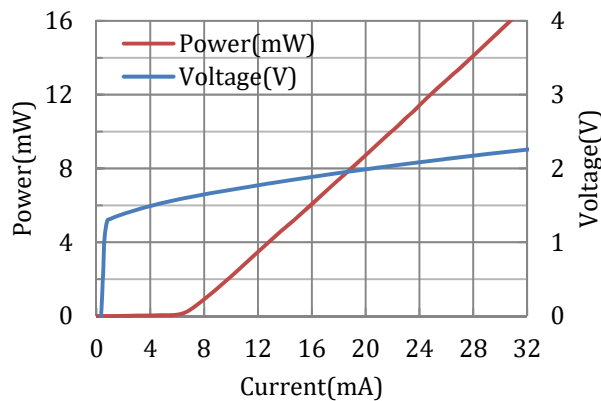
### THERMAL CHARACTERISTICS :

PARAMETERS	MIN	TYP	MAX	UNIT	CONDITIONS
$P_o$ Temperature Coefficient		-1.0		%/°C	$T_a=0\sim 70^\circ C / I_F=24mA$
$V_F$ Temperature Coefficient		-2.5		mV/°C	$T_a=0\sim 70^\circ C / I_F=24mA$
$\lambda_P$ Temperature Coefficient		0.065		nm/°C	$T_a=0\sim 70^\circ C / I_F=24mA$

### ABSOLUTE MAXIMUM RATINGS :

PARAMETERS	MIN	MAX	UNIT	CONDITIONS
Storage Temperature	-40	125	°C	
Operating Temperature	-20	70	°C	
Continuous Forward Current		30	mA	
Reverse Voltage		5	V	

### ELECTRO-OPTICAL CHARACTERIZATION :



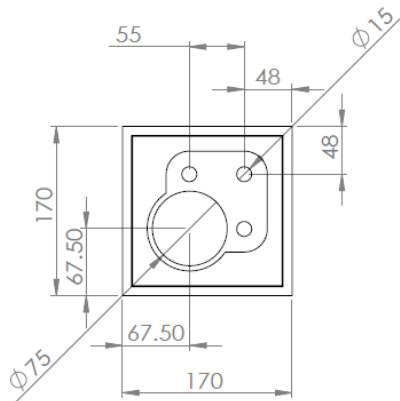
Typical electro / optical characteristics curves measured at 25°C, CW operation

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### OUTLINE DIAGRAM :

- Chip length :  $170 \mu\text{m} \pm 10 \mu\text{m}$
- Chip width :  $170 \mu\text{m} \pm 10 \mu\text{m}$
- Chip thickness :  $150 \pm 15 \mu\text{m}$
- Anode bond pad :  $\Phi 75 \mu\text{m} \pm 2 \mu\text{m}$



### WARNING :

The VCSEL is a class 3R laser in the safety standard IEC60825-1:2014 and avoid direct eye exposure.

